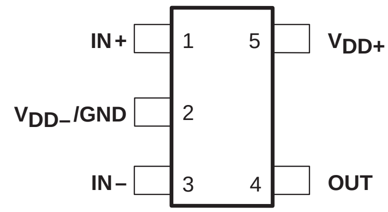
- **Output Swing Includes Both Supply Rails**
- **Low Noise . . . 21 nV/√Hz Typ at f = 1 kHz**
- **Low Input Bias Current . . . 1 pA Typ**
- **Very Low Power . . . 13 μA Per Channel Typ**
- **Common-Mode Input Voltage Range Includes Negative Rail**
- **Wide Supply Voltage Range 2.7 V to 10 V**
- **Available in the SOT-23 Package**
- **Macromodel Included**

**DBV PACKAGE
(TOP VIEW)**



description

The TLV2211 is a single operational amplifier manufactured using the Texas Instruments Advanced LinCMOS™ process. These devices are optimized and fully specified for single-supply 3-V and 5-V operation. For this low-voltage operation combined with micropower dissipation levels, the input noise voltage performance has been dramatically improved using optimized design techniques for CMOS-type amplifiers. Another added benefit is that these amplifiers exhibit rail-to-rail output swing. The output dynamic range can be extended using the TLV2211 with loads referenced midway between the rails. The common-mode input voltage range is wider than typical standard CMOS-type amplifiers. To take advantage of this improvement in performance and to make this device available for a wider range of applications, V_{ICR} is specified with a larger maximum input offset voltage test limit of ± 5 mV, allowing a minimum of 0 to 2-V common-mode input voltage range for a 3-V power supply.

AVAILABLE OPTIONS

T_A	V_{IO}max AT 25°C	PACKAGED DEVICES	SYMBOL	CHIP FORM (Y)
		SOT-23 (DBV)†		
0°C to 70°C	3 mV	TLV2211CDBV	VACC	TLV2211Y
–40°C to 85°C	3 mV	TLV2211IDBV	VACI	

† The DBV package available in tape and reel only.

The Advanced LinCMOS process uses a silicon-gate technology to obtain input offset voltage stability with temperature and time that far exceeds that obtainable using metal-gate technology. This technology also makes possible input-impedance levels that meet or exceed levels offered by top-gate JFET and expensive dielectric-isolated devices.

The TLV2211, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources such as piezoelectric transducers. Because of the low power dissipation levels combined with 3-V operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single or split supplies makes these devices excellent choices when interfacing directly to analog-to-digital converters (ADCs). All of these features combined with its temperature performance make the TLV2211 ideal for remote pressure sensors, temperature control, active voltage-resistive (VR) sensors, accelerometers, hand-held metering, and many other applications.

Advanced LinCMOS is a trademark of Texas Instruments Incorporated.

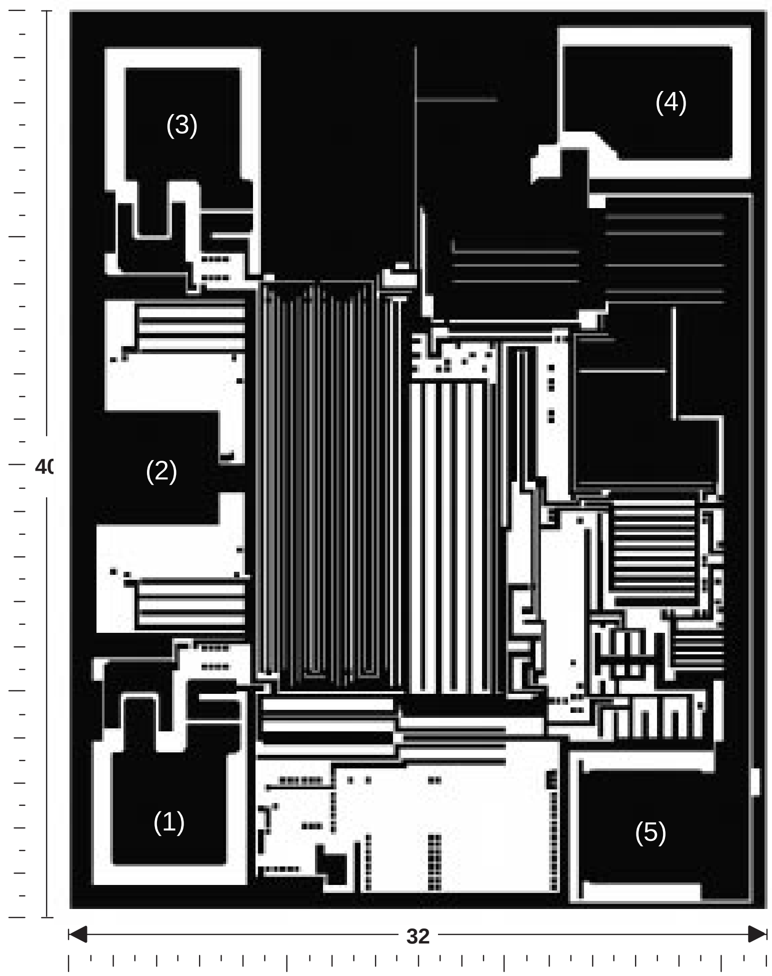
description (continued)

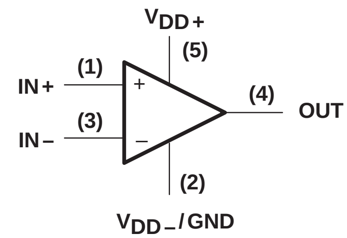
The device inputs and outputs are designed to withstand a 100-mA surge current without sustaining latch-up. In addition, internal ESD-protection circuits prevent functional failures up to 2000 V as tested under MIL-PRF-38535; however, care should be exercised when handling these devices as exposure to ESD may result in degradation of the device parametric performance. Additional care should be exercised to prevent V_{DD+} supply-line transients under powered conditions. Transients of greater than 20 V can trigger the ESD-protection structure, inducing a low-impedance path to V_{DD-}/GND. Should this condition occur, the sustained current supplied to the device must be limited to 100 mA or less. Failure to do so could result in a latched condition and device failure.

TLV2211Y chip information

This chip, when properly assembled, displays characteristics similar to the TLV2211C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. This chip may be mounted with conductive epoxy or a gold-silicon preform.

BONDING PAD ASSIGNMENTS





CHIP THICKNESS: 10 MILS TYPICAL

BONDING PADS: 4 × 4 MILS MINIMUM

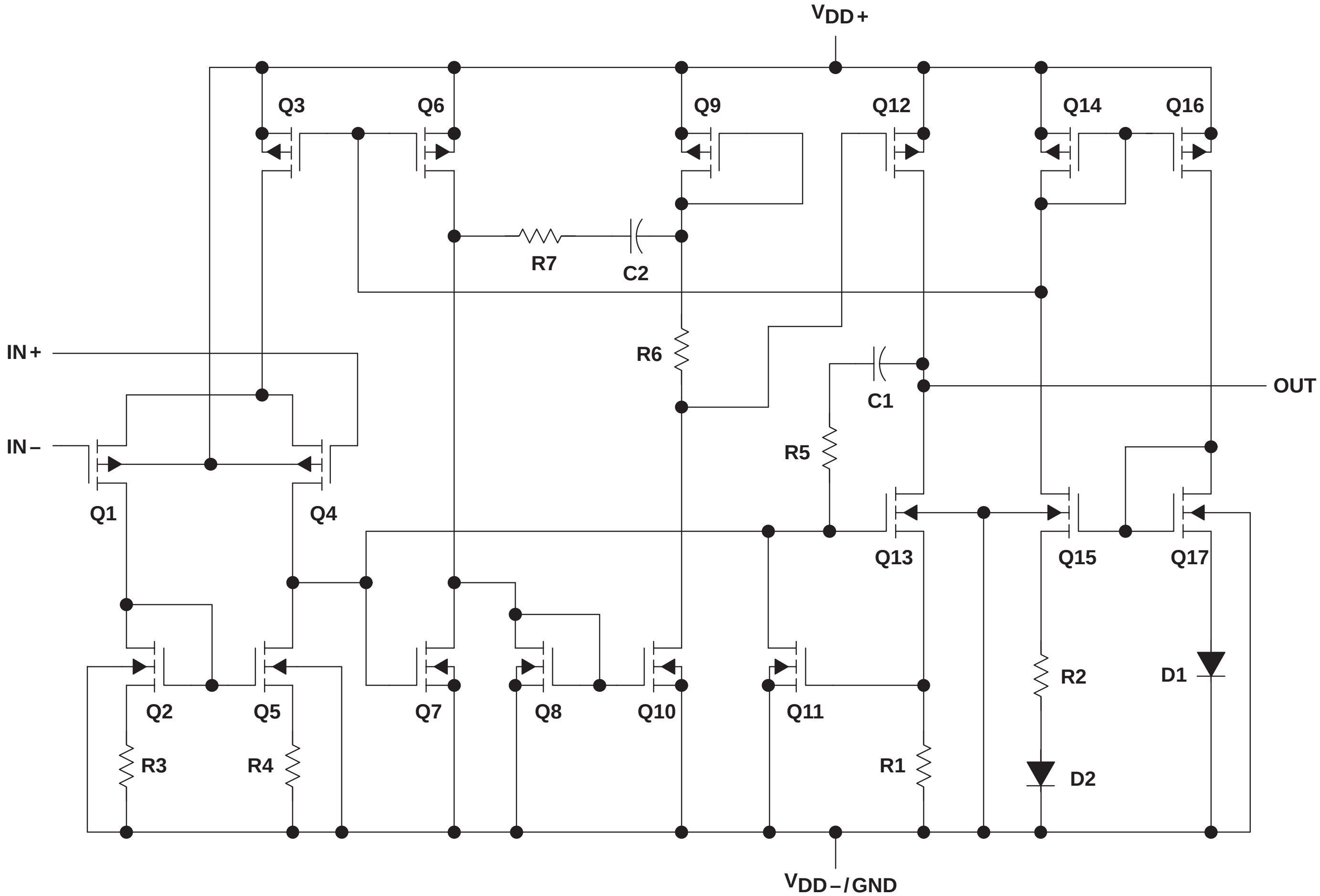
$T_J$max = 150°C

TOLERANCES ARE ±10%.

ALL DIMENSIONS ARE IN MILS.

PIN (2) IS INTERNALLY CONNECTED TO BACKSIDE OF CHIP.

equivalent schematic



COMPONENT COUNT†	
Transistors	23
Diodes	6
Resistors	11
Capacitors	2

† Includes both amplifiers and all ESD, bias, and trim circuitry

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{DD} (see Note 1) . . . 12 V
Differential input voltage, V_{ID} (see Note 2) . . . $\pm V_{DD}$
Input voltage range, V_I (any input, see Note 1) . . . –0.3 V to V_{DD}
Input current, I_I (each input) . . . ±5 mA
Output current, I_O . . . ±50 mA
Total current into V_{DD+} . . . ±50 mA
Total current out of V_{DD-} . . . ±50 mA
Duration of short-circuit current (at or below) 25°C (see Note 3) . . . unlimited
Continuous total power dissipation . . . See Dissipation Rating Table
Operating free-air temperature range, T_A: TLV2211C . . . 0°C to 70°C
TLV2211I . . . –40°C to 85°C
Storage temperature range, T_{stg} . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DBV package . . . 260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to V_{DD-}.
2. Differential voltages are at the noninverting input with respect to the inverting input. Excessive current flows when input is brought below V_{DD-} – 0.3 V.
3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 85°C$ POWER RATING
DBV	150 mW	1.2 mW/°C	96 mW	78 mW

recommended operating conditions

	TLV2211C		TLV2211I		UNIT
	MIN	MAX	MIN	MAX	
Supply voltage, V_{DD} (see Note 1)	2.7	10	2.7	10	V
Input voltage range, V_I	V_{DD-}	$V_{DD+}-1.3$	V_{DD-}	$V_{DD+}-1.3$	V
Common-mode input voltage, V_{IC}	V_{DD-}	$V_{DD+}-1.3$	V_{DD-}	$V_{DD+}-1.3$	V
Operating free-air temperature, T_A	0	70	–40	85	°C

NOTE 1: All voltage values, except differential voltages, are with respect to V_{DD-}.

electrical characteristics at specified free-air temperature, V_{DD} = 3 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T_A†	TLV2211C MIN	TLV2211C TYP	TLV2211C MAX	TLV2211I MIN	TLV2211I TYP	TLV2211I MAX	UNIT
V_{IO}	Input offset voltage	$V_{DD\pm} = \pm 1.5$ V, V_O = 0,	V_{IC} = 0, R_S = 50 Ω	Full range		0.47	3		0.47	3000	mV
α_{VIO}	Temperature coefficient of input offset voltage			Full range		1			1		μV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.003			0.003		μV/mo
I_{IO}	Input offset current			Full range		0.5	150		0.5	150	pA
I_{IB}	Input bias current			Full range		1	150		1	150	pA
V_{ICR}	Common-mode input voltage range	$\lvert V_{IO} \rvert \le 5$ mV,	R_S = 50 Ω	25°C	0 to 2	–0.3 to 2.2		0 to 2	–0.3 to 2.2		V
				Full range	0 to 1.7			0 to 1.7			
V_{OH}	High-level output voltage	I_{OH} = –100 μA		25°C		2.94			2.94		V
		I_{OH} = –250 μA		25°C		2.85			2.85		
				Full range	2.5			2.5			
V_{OL}	Low-level output voltage	V_{IC} = 1.5 V,	I_{OL} = 50 μA	25°C		15			15		mV
		V_{IC} = 1.5 V,	I_{OL} = 500 μA	25°C		150			150		
				Full range			500			500	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1.5 V, V_O = 1 V to 2 V	R_L = 10 kΩ‡	25°C	3	7		3	7		V/mV
				Full range	1			1			
			R_L = 1 MΩ‡	25°C		600			600		
$r_{i(d)}$	Differential input resistance			25°C		10^{12}			10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance			25°C		10^{12}			10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz,		25°C		5			5		pF
z_o	Closed-loop output impedance	f = 7 kHz,	A_V = 1	25°C		200			200		Ω
CMRR	Common-mode rejection ratio	V_{IC} = 0 to 1.7 V, R_S = 50 Ω	V_O = 1.5 V,	25°C	65	83		65	83		dB
				Full range	60			60			
k_{SVR}	Supply voltage rejection ratio ($\Delta V_{DD} / \Delta V_{IO}$)	V_{DD} = 2.7 V to 8 V, No load	$V_{IC} = V_{DD}/2$,	25°C	80	95		80	95		dB
				Full range	80			80			
I_{DD}	Supply current	V_O = 1.5 V,	No load	25°C		11	25		11	25	μA
				Full range			30			30	

† Full range for the TLV2211C is 0°C to 70°C. Full range for the TLV2211I is – 40°C to 85°C.
‡ Referenced to 1.5 V
NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, V_{DD} = 3 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLV2211C			TLV2211I			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain	V_O = 1.1 V to 1.9 V, R_L = 10 kΩ‡, C_L = 100 pF‡	25°C	0.01	0.025		0.01	0.025		V/µs
			Full range	0.005			0.005			
V_n	Equivalent input noise voltage	f = 10 Hz	25°C		80			80		nV/√Hz
		f = 1 kHz	25°C		22			22		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz	25°C		660			660		µV
		f = 0.1 Hz to 10 Hz	25°C		880			880		
I_n	Equivalent input noise current		25°C		0.6			0.6		fA /√Hz
	Gain-bandwidth product	f = 10 kHz, R_L = 10 kΩ‡, C_L = 100 pF‡	25°C		56			56		kHz
B_{OM}	Maximum output-swing bandwidth	$V_{O(PP)}$ = 1 V, A_V = 1, R_L = 10 kΩ‡, C_L = 100 pF‡	25°C		7			7		kHz
ϕ_m	Phase margin at unity gain	R_L = 10 kΩ‡, C_L = 100 pF‡	25°C		56°			56°		
	Gain margin		25°C		20			20		dB

† Full range is –40°C to 85°C.
‡ Referenced to 1.5 V

electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T_A†	TLV2211C			TLV2211I			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	$V_{DD\pm} = \pm 2.5$ V, $V_O = 0$,	$V_{IC} = 0$, $R_S = 50\ \Omega$	Full range		0.45	3		0.45	3	mV
α_{VIO}	Temperature coefficient of input offset voltage			Full range		0.5			0.5		µV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.003			0.003		µV/mo
I_{IO}	Input offset current			25°C		0.5			0.5		pA
				Full range			150			150	
I_{IB}	Input bias current			25°C		1			1		pA
				Full range			150			150	
V_{ICR}	Common-mode input voltage range	$\|V_{IO}\| \le 5$ mV	$R_S = 50\ \Omega$	25°C	0 to 4	−0.3 to 4.2		0 to 4	−0.3 to 4.2		V
				Full range	0 to 3.5			0 to 3.5			
V_{OH}	High-level output voltage	$I_{OH} = -100\ \mu A$		25°C		4.95			4.95		V
		$I_{OH} = -250\ \mu A$		25°C		4.875			4.875		
				Full range	4.5			4.5			
V_{OL}	Low-level output voltage	$V_{IC} = 2.5$ V,	$I_{OL} = 50\ \mu A$	25°C		12			12		mV
		$V_{IC} = 2.5$ V,	$I_{OL} = 500\ \mu A$	25°C		120			120		
				Full range			500			500	
A_{VD}	Large-signal differential voltage amplification	$V_{IC} = 2.5$ V, $V_O = 1$ V to 4 V	$R_L = 10\ k\Omega$‡	25°C	6	12		6	12		V/mV
				Full range	3			3			
			$R_L = 1\ M\Omega$‡	25°C		800			800		
$r_{i(d)}$	Differential input resistance			25°C		10^{12}			10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance			25°C		10^{12}			10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz,		25°C		5			5		pF
z_o	Closed-loop output impedance	f = 7 kHz,	$A_V = 1$	25°C		200			200		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = 0$ to 2.7 V, $R_S = 50\ \Omega$	$V_O = 2.5$ V,	25°C	70	83		70	83		dB
				Full range	70			70			
k_{SVR}	Supply voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	$V_{DD} = 4.4$ V to 8 V, No load	$V_{IC} = V_{DD}/2$,	25°C	80	95		80	95		dB
				Full range	80			80			
I_{DD}	Supply current	$V_O = 2.5$ V,	No load	25°C		13	25		13	25	µA
				Full range			30			30	

† Full range for the TLV2211C is 0°C to 70°C. Full range for the TLV2211I is – 40°C to 85°C.
‡ Referenced to 1.5 V
NOTE 5: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLV2211C			TLV2211I			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain	V_O = 1.5 V to 3.5 V, R_L = 10 kΩ‡, C_L = 100 pF‡	25°C	0.01	0.025		0.01	0.025		V/μs
			Full range	0.005			0.005			
V_n	Equivalent input noise voltage	f = 10 Hz	25°C		72			72		nV/√Hz
		f = 1 kHz	25°C		21			21		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz	25°C		600			600		μV
		f = 0.1 Hz to 10 Hz	25°C		800			800		
I_n	Equivalent input noise current		25°C		0.6			0.6		fA/√Hz
	Gain-bandwidth product	f = 10 kHz, R_L = 10 kΩ‡, C_L = 100 pF‡	25°C		65			65		kHz
B_{OM}	Maximum output-swing bandwidth	$V_{O(PP)}$ = 2 V, A_V = 1, R_L = 10 kΩ‡, C_L = 100 pF‡	25°C		7			7		kHz
ϕ_m	Phase margin at unity gain	R_L = 10 kΩ‡, C_L = 100 pF‡	25°C		56°			56°		
	Gain margin		25°C		22			22		dB

† Full range is –40°C to 85°C.
‡ Referenced to 1.5 V

electrical characteristics at V_{DD} = 3 V, T_A = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS				TLV2211Y			UNIT
						MIN	TYP	MAX	
V_{IO}	Input offset voltage	$V_{DD\pm}$ = ±1.5 V, R_S = 50 Ω	V_O = 0,	V_{IC} = 0,			0.47		mV
I_{IO}	Input offset current						0.5		pA
I_{IB}	Input bias current						1		pA
V_{ICR}	Common-mode input voltage range	$\lvert V_{IO} \rvert \le$ 5 mV,	R_S = 50 Ω				–0.3 to 2.2		V
V_{OH}	High-level output voltage	I_{OH} = –100 μA					2.94		V
		I_{OH} = –200 μA					2.85		
V_{OL}	Low-level output voltage	V_{IC} = 0,	I_{OL} = 50 μA				15		mV
		V_{IC} = 0,	I_{OL} = 500 μA				150		
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1.5 V,	V_O = 1 V to 2 V		R_L = 10 kΩ†		7		V/mV
					R_L = 1 MΩ†		600		
$r_{i(d)}$	Differential input resistance						10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance						10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz					5		pF
z_o	Closed-loop output impedance	f = 7 kHz,	A_V = 1				200		Ω
CMRR	Common-mode rejection ratio	V_{IC} = 0 to 1.7 V,	V_O = 1.5 V,	R_S = 50 Ω			83		dB
k_{SVR}	Supply voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 2.7 V to 8 V,	$V_{IC} = V_{DD}/2$,	No load			95		dB
I_{DD}	Supply current	V_O = 1.5 V,	No load				11		μA

† Referenced to 1.5 V

electrical characteristics at V_{DD} = 5 V, T_A = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS			TLV2211Y MIN	TLV2211Y TYP	TLV2211Y MAX	UNIT
V_{IO}	Input offset voltage	$V_{DD}\pm = \pm 2.5$ V, R_S = 50 Ω	V_{IC} = 0,	V_O = 0,		0.45		mV
I_{IO}	Input offset current					0.5		pA
I_{IB}	Input bias current					1		pA
V_{ICR}	Common-mode input voltage range	$\|V_{IO}\| \leq 5$ mV,	R_S = 50 Ω			–0.3 to 4.2		V
V_{OH}	High-level output voltage	I_{OH} = –100 µA				4.95		V
		I_{OH} = –250 µA				4.875		
V_{OL}	Low-level output voltage	V_{IC} = 2.5 V,	I_{OL} = 50 µA			12		mV
		V_{IC} = 2.5 V,	I_{OL} = 500 µA			120		
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 2.5 V,	V_O = 1 V to 4 V	R_L = 10 kΩ†		12		V/mV
				R_L = 1 MΩ†		800		
$r_{i(d)}$	Differential input resistance					10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance					10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz				5		pF
z_o	Closed-loop output impedance	f = 7 kHz,	A_V = 1			200		Ω
CMRR	Common-mode rejection ratio	V_{IC} = 0 to 2.7 V,	V_O = 2.5 V,	R_S = 50 Ω		83		dB
k_{SVR}	Supply voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 4.4 V to 8 V,	$V_{IC} = V_{DD}/2$,	No load		95		dB
I_{DD}	Supply current	V_O = 2.5 V,	No load			13		µA

† Referenced to 1.5 V

TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
V_{IO}	Input offset voltage	Distribution vs Common-mode input voltage	1, 2 3, 4
α_{VIO}	Input offset voltage temperature coefficient	Distribution	5, 6
I_{IB}/I_{IO}	Input bias and input offset currents	vs Free-air temperature	7
V_I	Input voltage	vs Supply voltage vs Free-air temperature	8 9
V_{OH}	High-level output voltage	vs High-level output current	10, 13
V_{OL}	Low-level output voltage	vs Low-level output current	11, 12, 14
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	15
I_{OS}	Short-circuit output current	vs Supply voltage vs Free-air temperature	16 17
V_O	Output voltage	vs Differential input voltage	18, 19
A_{VD}	Differential voltage amplification	vs Load resistance vs Frequency vs Free-air temperature	20 21, 22 23, 24
z_o	Output impedance	vs Frequency	25, 26
CMRR	Common-mode rejection ratio	vs Frequency vs Free-air temperature	27 28
k_{SVR}	Supply-voltage rejection ratio	vs Frequency vs Free-air temperature	29, 30 31
I_{DD}	Supply current	vs Supply voltage	32
SR	Slew rate	vs Load capacitance vs Free-air temperature	33 34
V_O	Large-signal pulse response	vs Time	35, 36, 37, 38
V_O	Small-signal pulse response	vs Time	39, 40, 41, 42
V_n	Equivalent input noise voltage	vs Frequency	43, 44
	Noise voltage (referred to input)	Over a 10-second period	45
THD + N	Total harmonic distortion plus noise	vs Frequency	46
	Gain-bandwidth product	vs Free-air temperature vs Supply voltage	47 48
ϕ_m	Phase margin	vs Frequency vs Load capacitance	21, 22 49
	Gain margin	vs Load capacitance	50
B_1	Unity-gain bandwidth	vs Load capacitance	51

TYPICAL CHARACTERISTICS

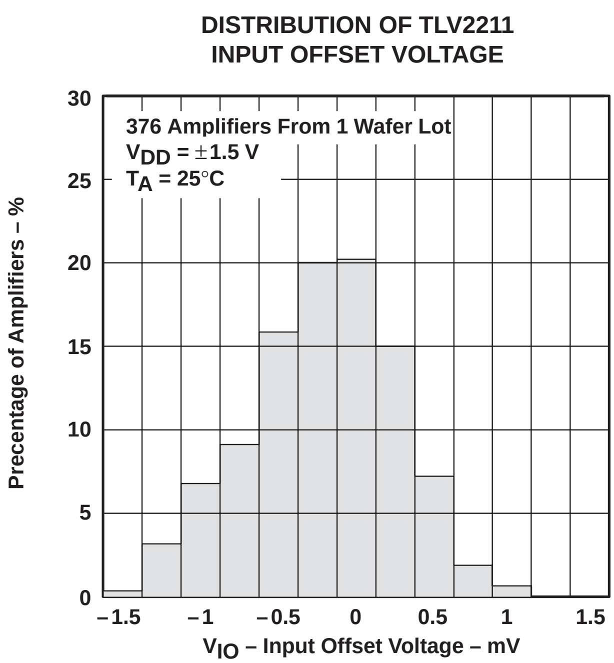


Figure 1

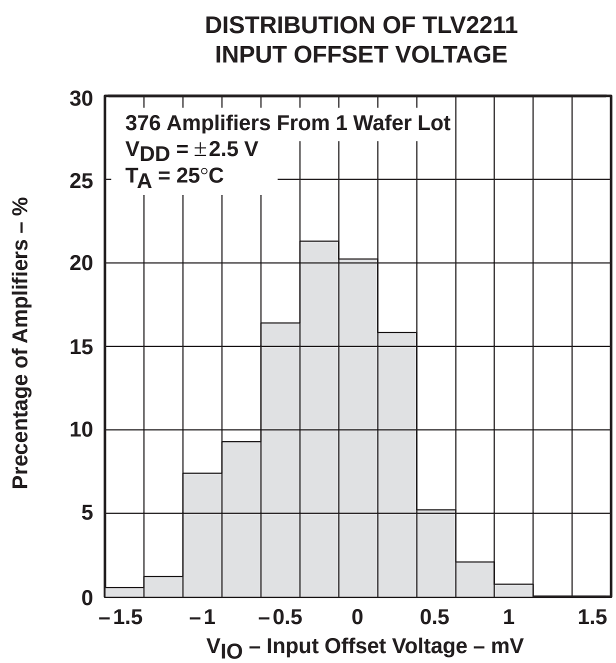


Figure 2

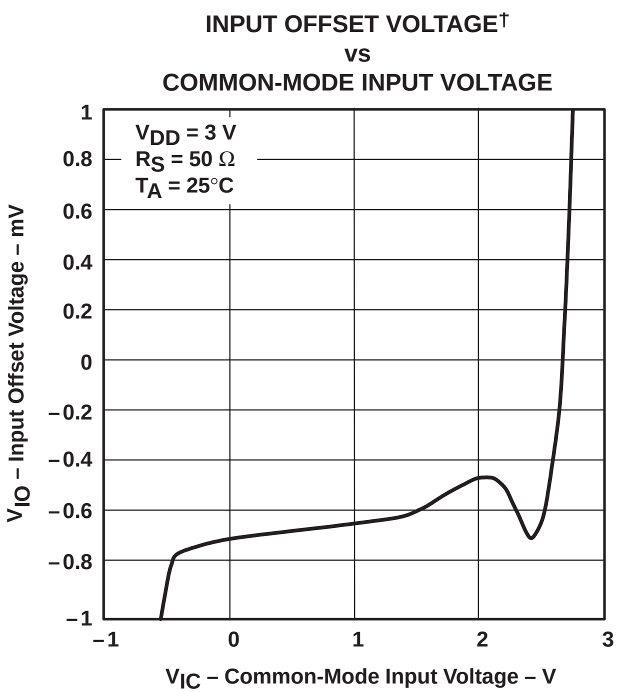


Figure 3

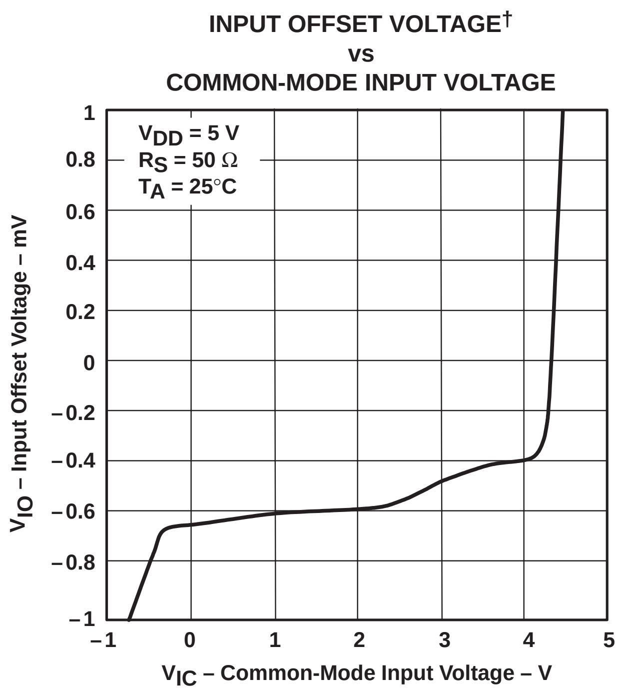


Figure 4

† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

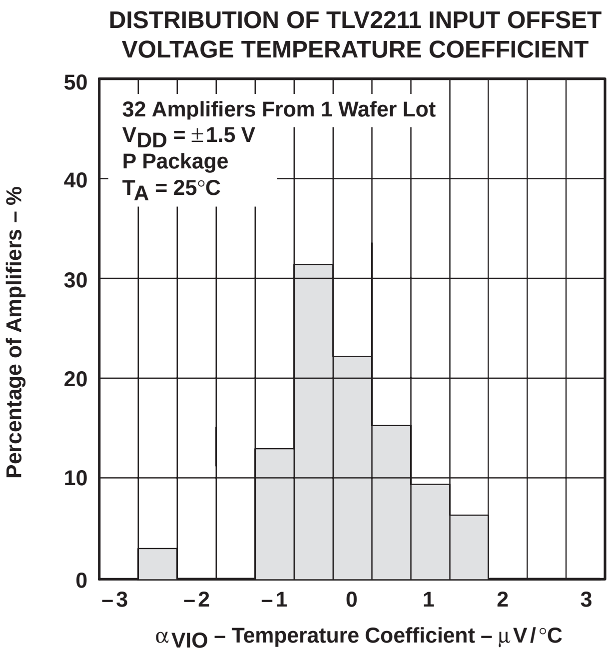


Figure 5

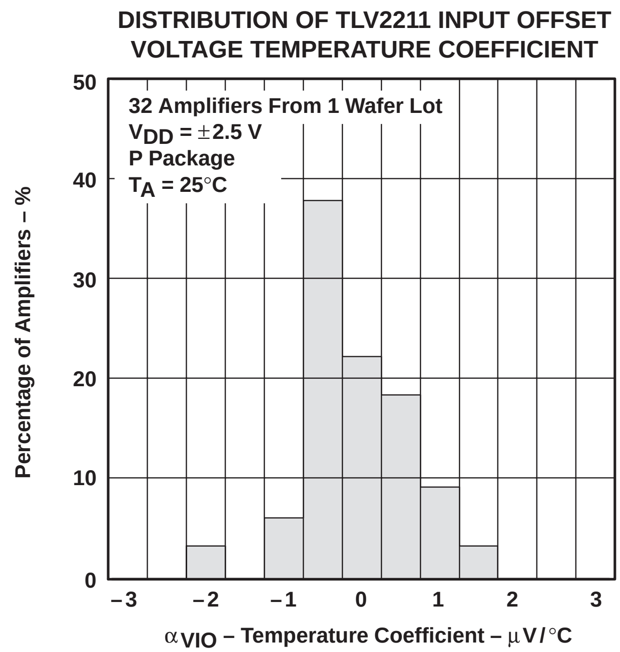


Figure 6

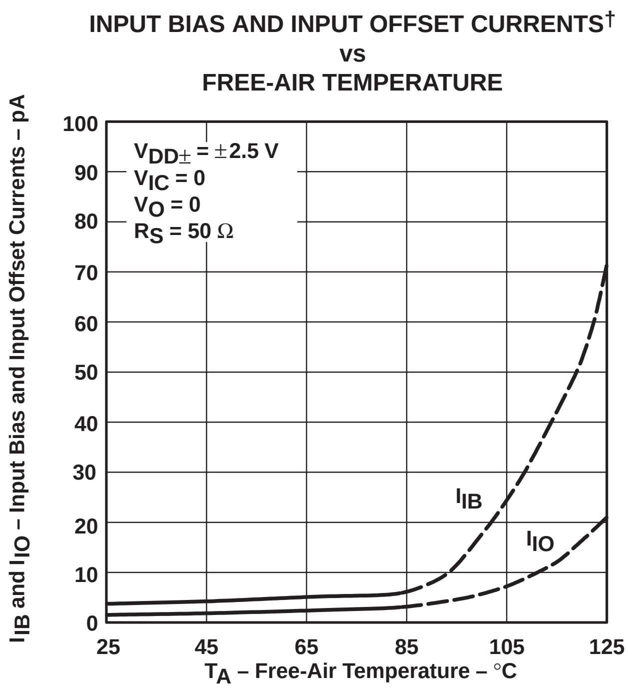


Figure 7

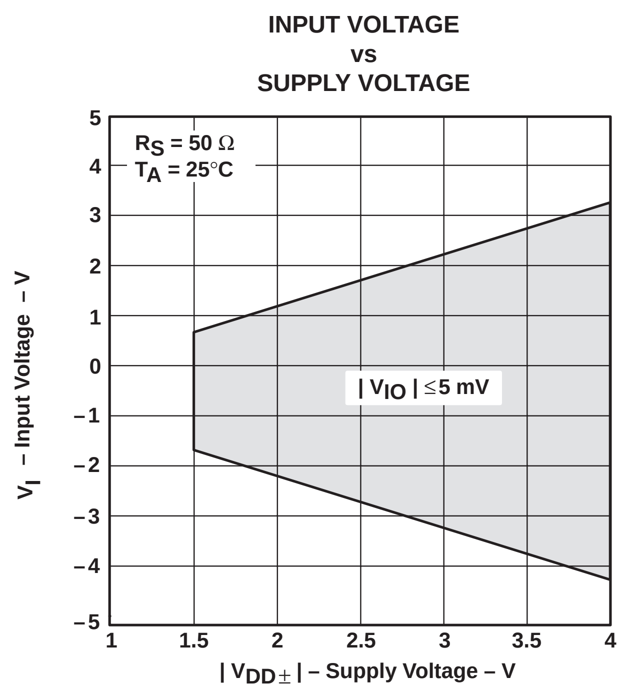


Figure 8

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

INPUT VOLTAGE†‡ vs FREE-AIR TEMPERATURE

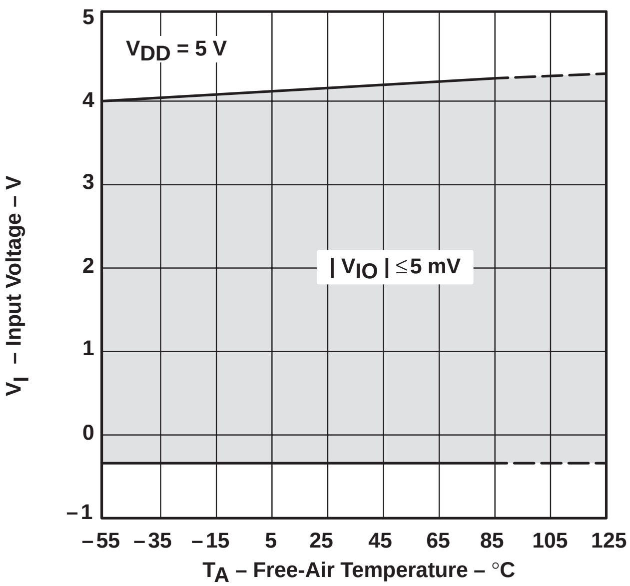


Figure 9

HIGH-LEVEL OUTPUT VOLTAGE†‡ vs HIGH-LEVEL OUTPUT CURRENT

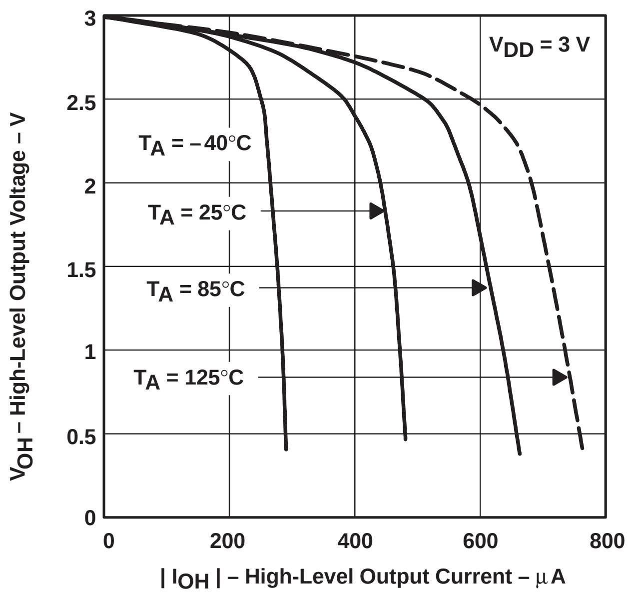


Figure 10

LOW-LEVEL OUTPUT VOLTAGE‡ vs LOW-LEVEL OUTPUT CURRENT

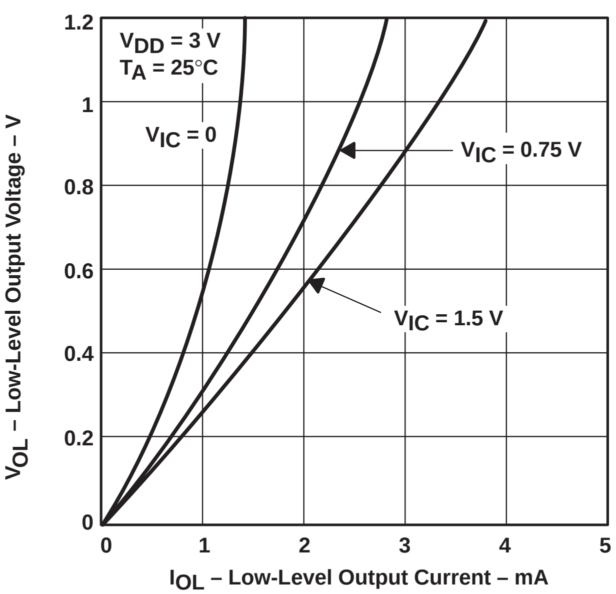


Figure 11

LOW-LEVEL OUTPUT VOLTAGE†‡ vs LOW-LEVEL OUTPUT CURRENT

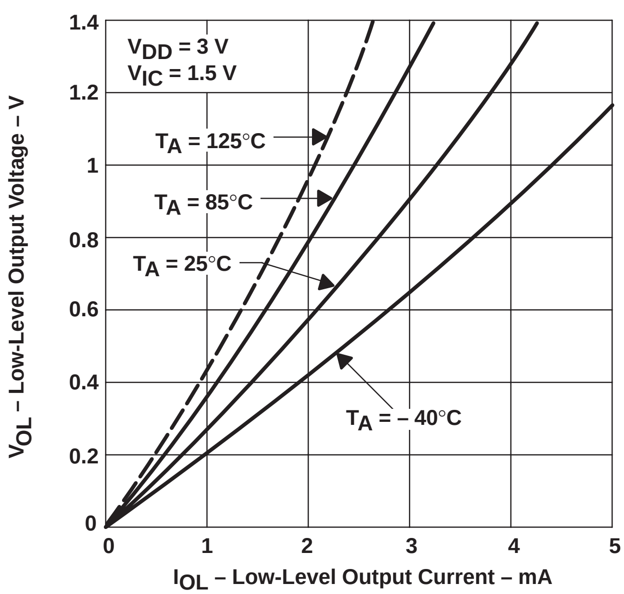


Figure 12

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.
‡ For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

HIGH-LEVEL OUTPUT VOLTAGE†‡ vs HIGH-LEVEL OUTPUT CURRENT

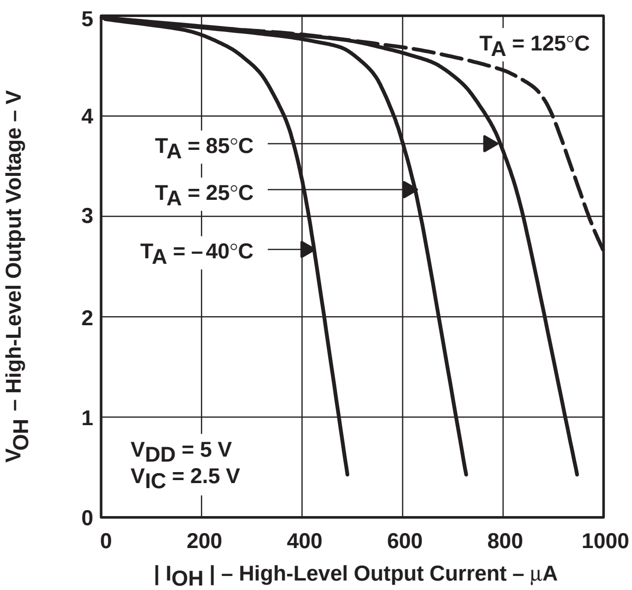


Figure 13

LOW-LEVEL OUTPUT VOLTAGE†‡ vs LOW-LEVEL OUTPUT CURRENT

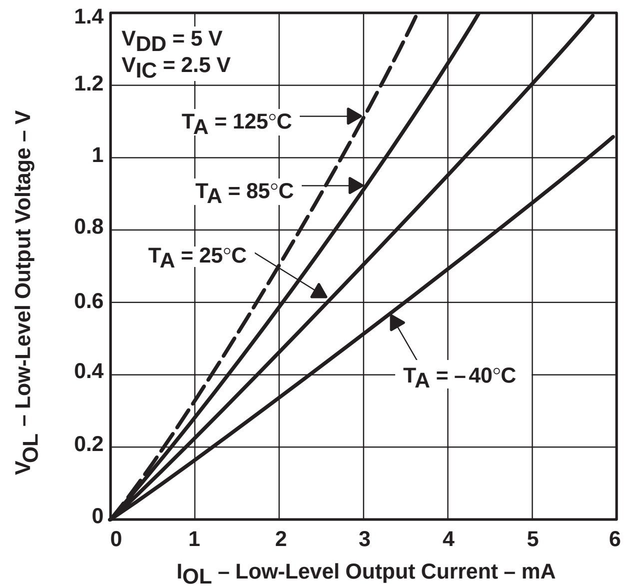


Figure 14

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE‡ vs FREQUENCY

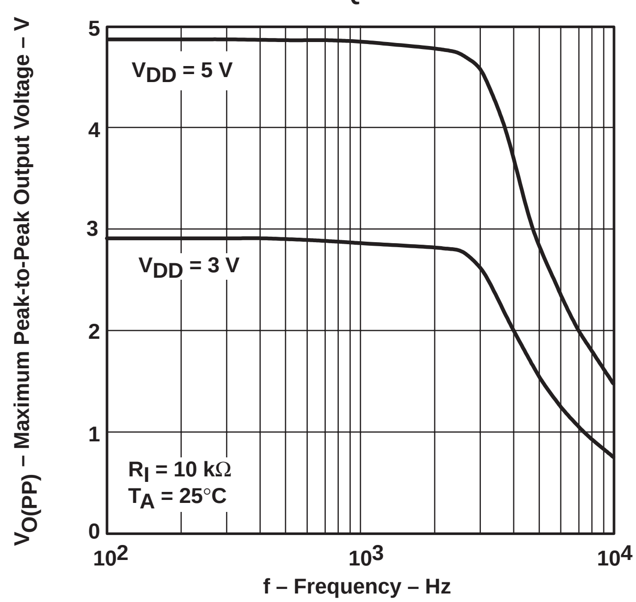


Figure 15

SHORT-CIRCUIT OUTPUT CURRENT vs SUPPLY VOLTAGE

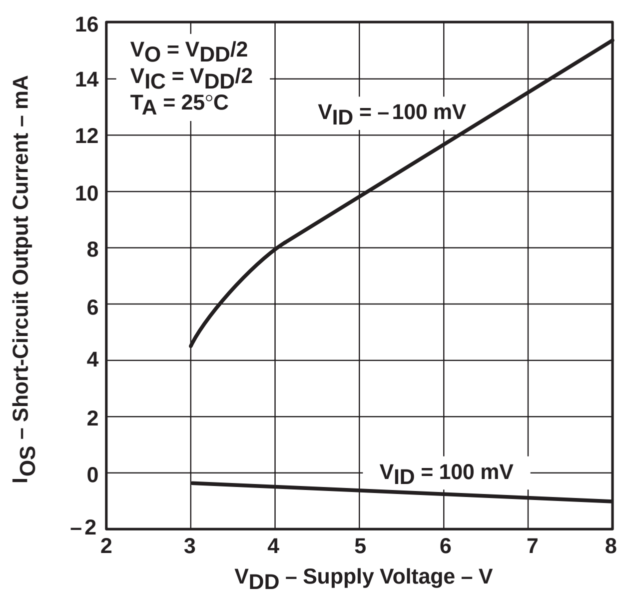


Figure 16

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.
‡ For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

SHORT-CIRCUIT OUTPUT CURRENT†‡ vs FREE-AIR TEMPERATURE

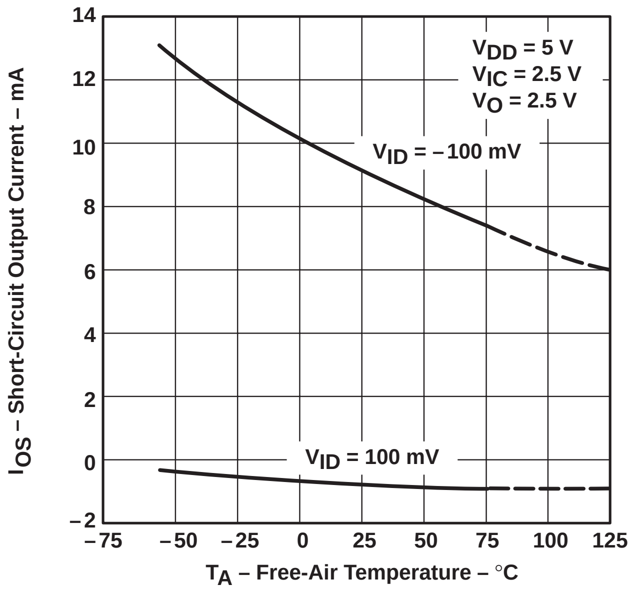


Figure 17

OUTPUT VOLTAGE‡ vs DIFFERENTIAL INPUT VOLTAGE

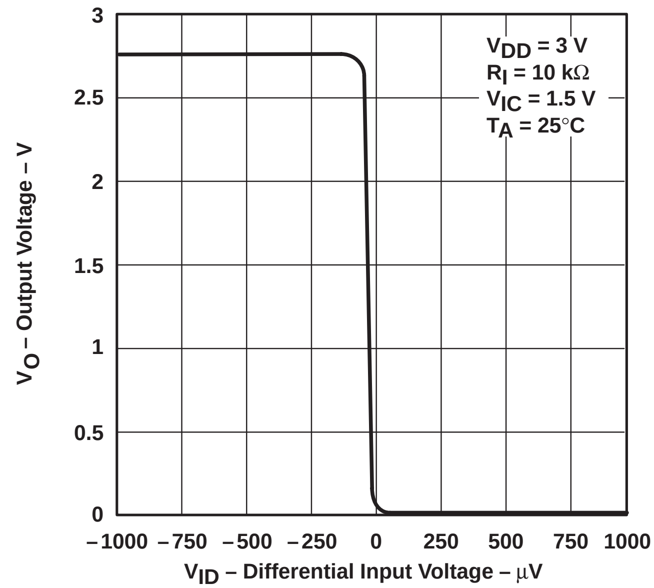


Figure 18

OUTPUT VOLTAGE‡ vs DIFFERENTIAL INPUT VOLTAGE

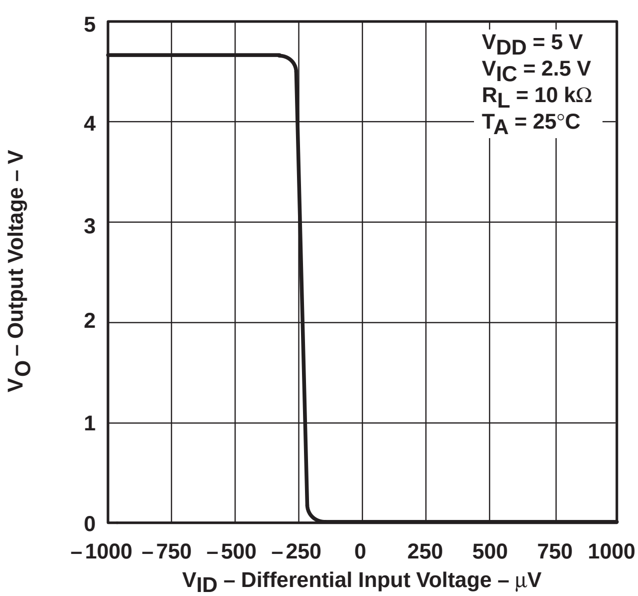


Figure 19

DIFFERENTIAL VOLTAGE AMPLIFICATION‡ vs LOAD RESISTANCE

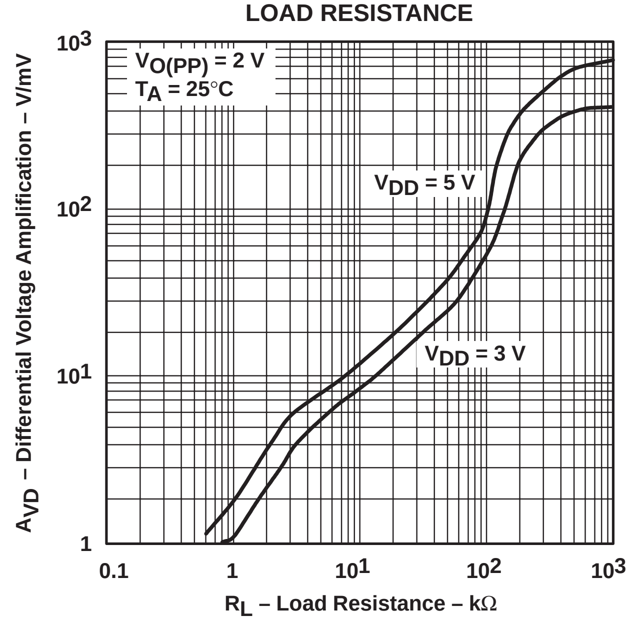


Figure 20

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.
‡ For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

**LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN†
vs
FREQUENCY**

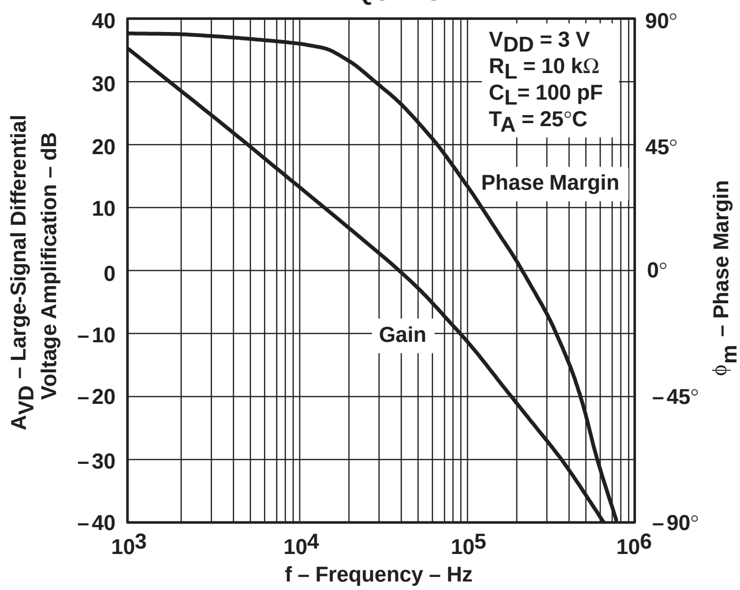


Figure 21

**LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN†
vs
FREQUENCY**

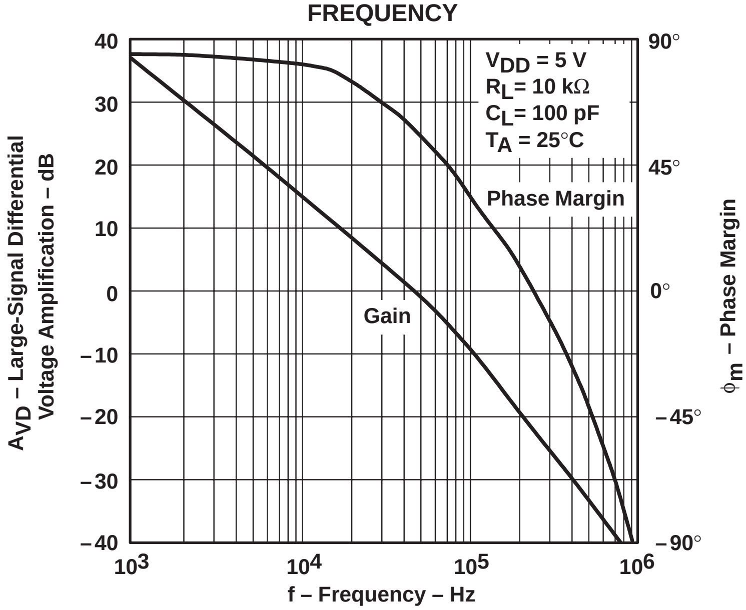


Figure 22

† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION†‡ vs FREE-AIR TEMPERATURE

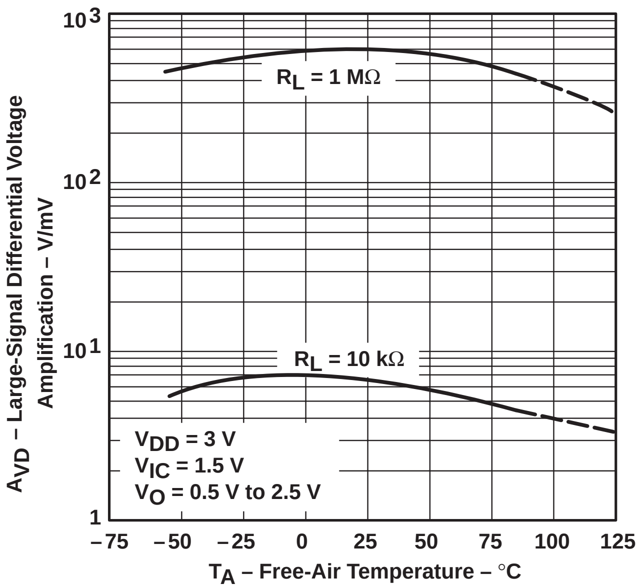


Figure 23

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION†‡ vs FREE-AIR TEMPERATURE

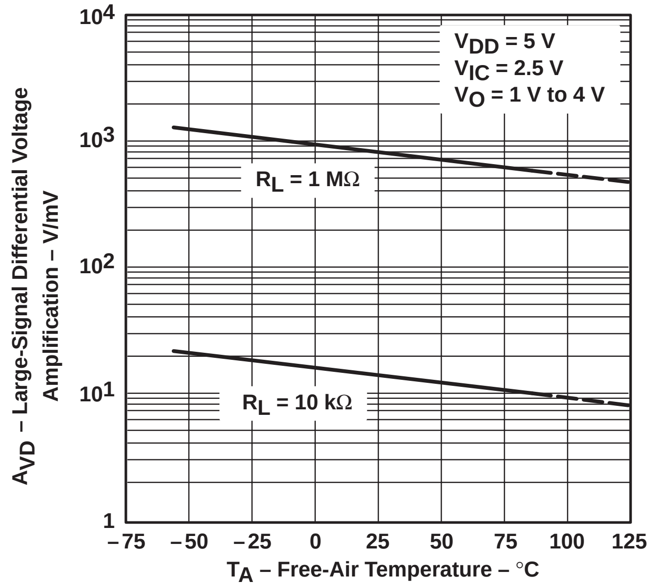


Figure 24

OUTPUT IMPEDANCE‡ vs FREQUENCY

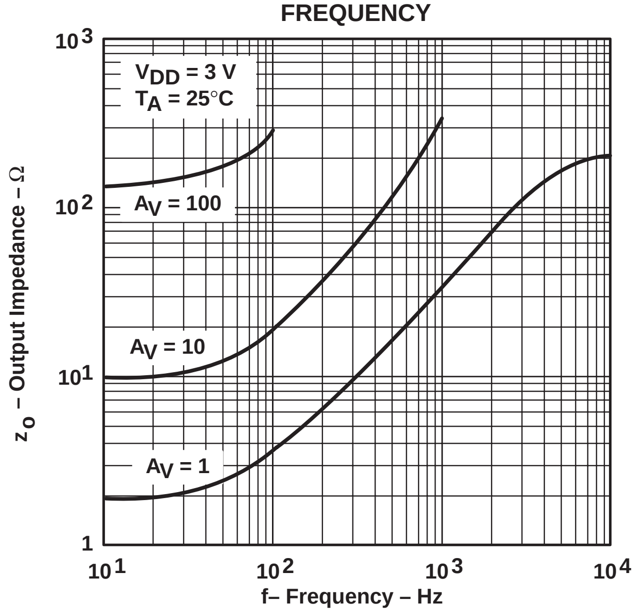


Figure 25

OUTPUT IMPEDANCE‡ vs FREQUENCY

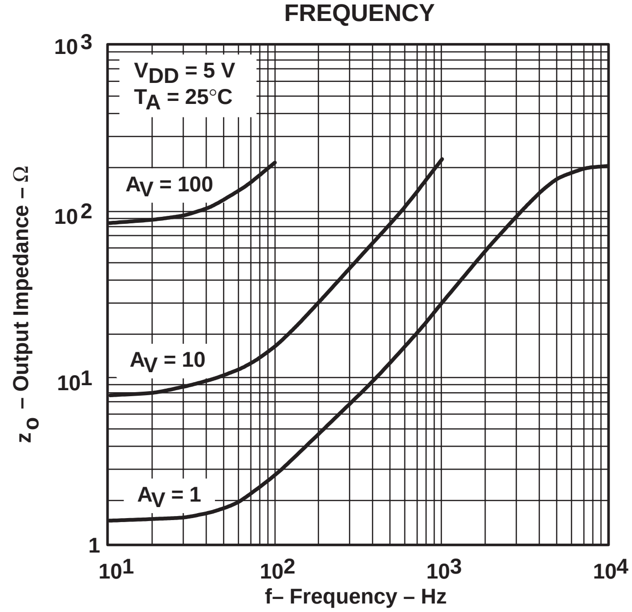


Figure 26

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.
‡ For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

COMMON-MODE REJECTION RATIO† vs FREQUENCY

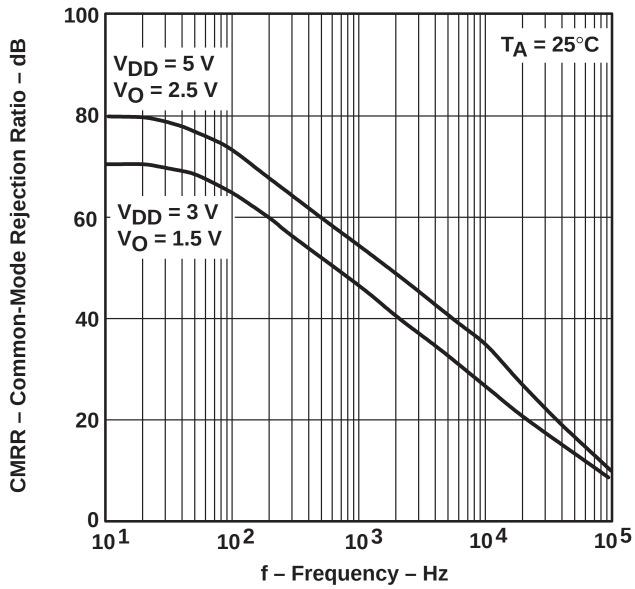


Figure 27

COMMON-MODE REJECTION RATIO†‡ vs FREE-AIR TEMPERATURE

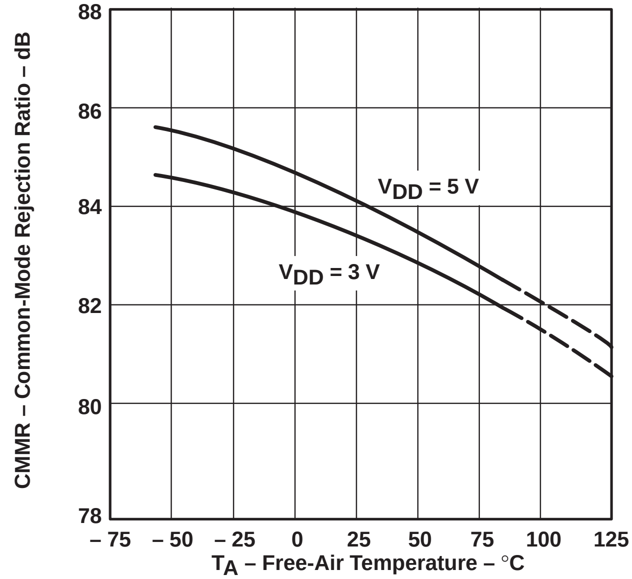


Figure 28

SUPPLY-VOLTAGE REJECTION RATIO† vs FREQUENCY

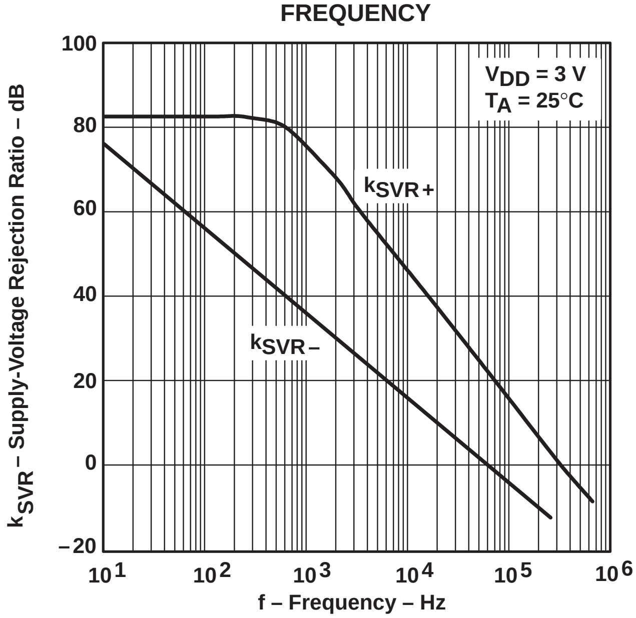


Figure 29

SUPPLY-VOLTAGE REJECTION RATIO† vs FREQUENCY

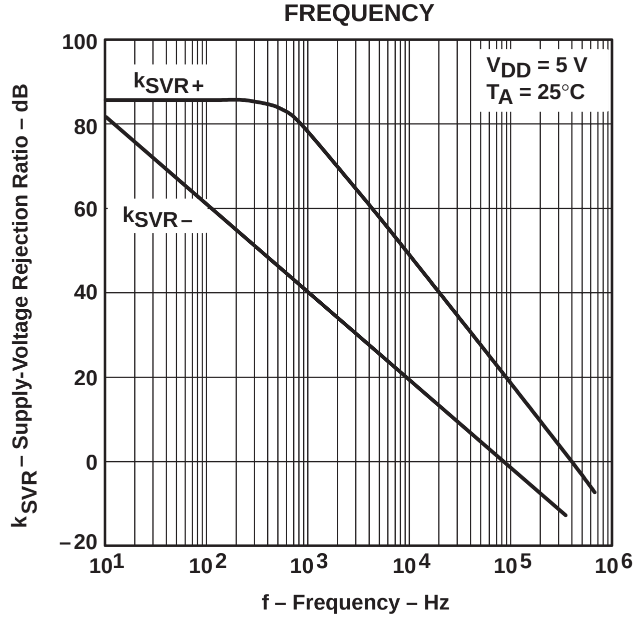


Figure 30

† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.
‡ Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

SUPPLY-VOLTAGE REJECTION RATIO†
vs
FREE-AIR TEMPERATURE

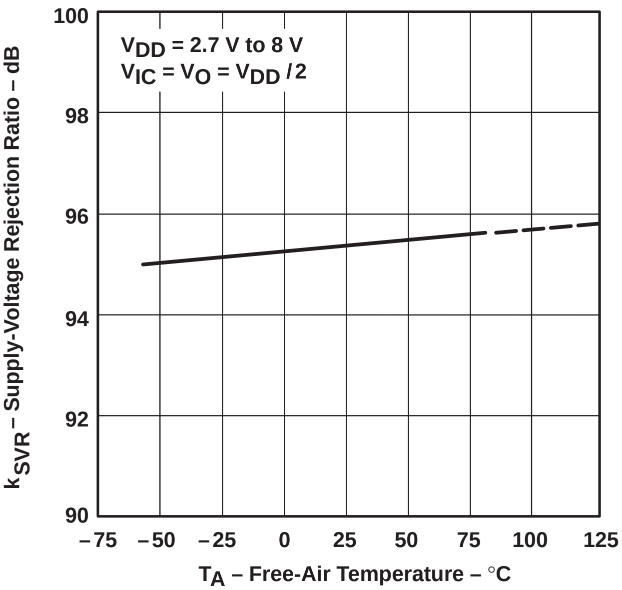


Figure 31

SUPPLY CURRENT†
vs
SUPPLY VOLTAGE

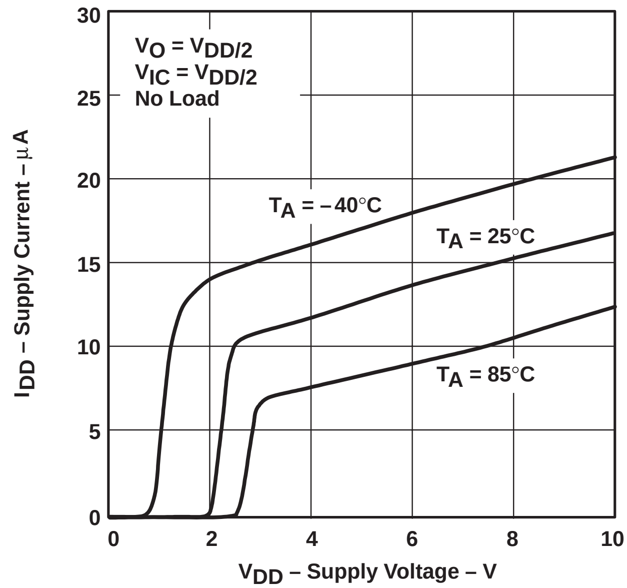


Figure 32

SLEW RATE‡
vs
LOAD CAPACITANCE

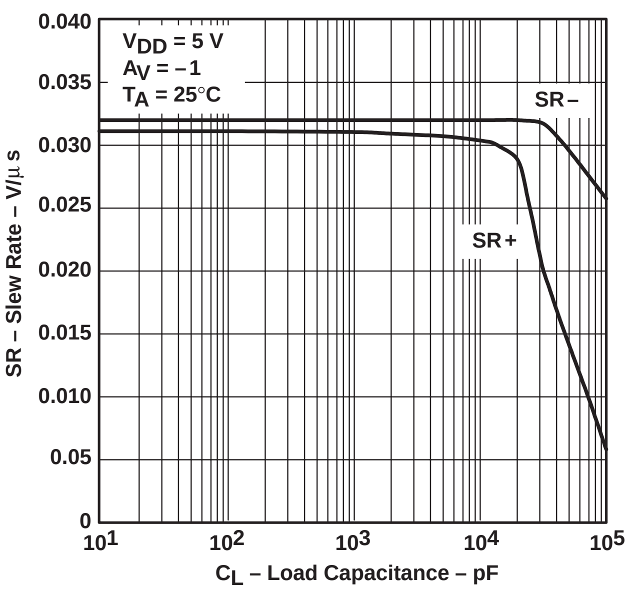


Figure 33

SLEW RATE†‡
vs
FREE-AIR TEMPERATURE

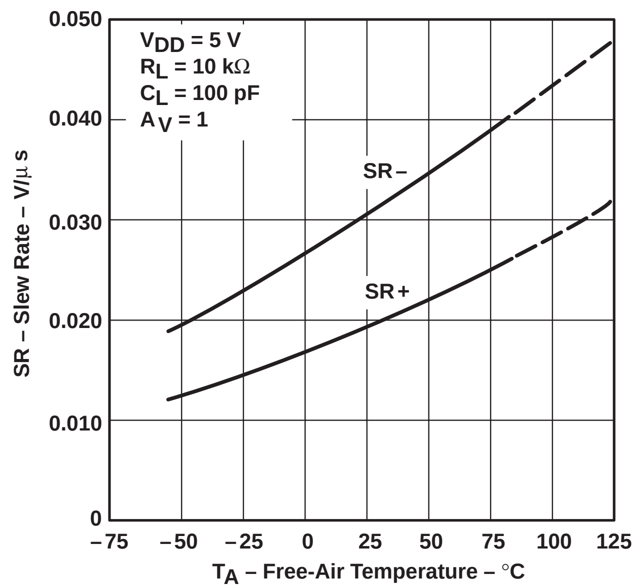


Figure 34

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.
‡ For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

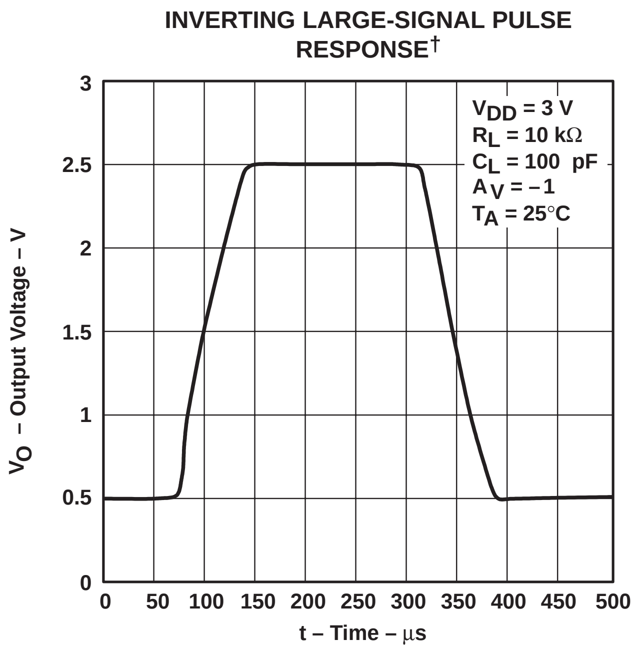


Figure 35

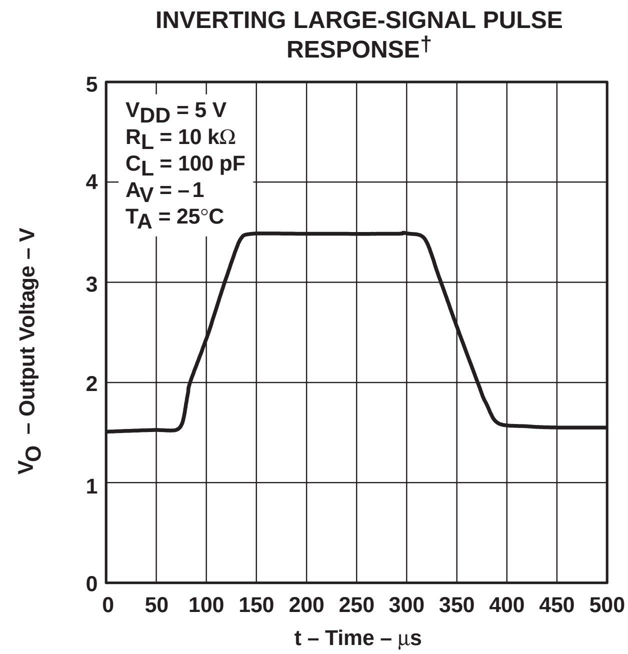


Figure 36

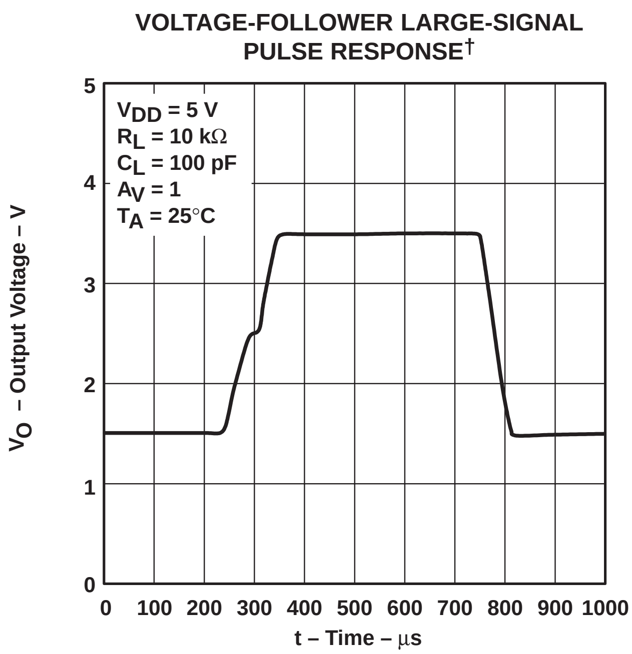


Figure 37

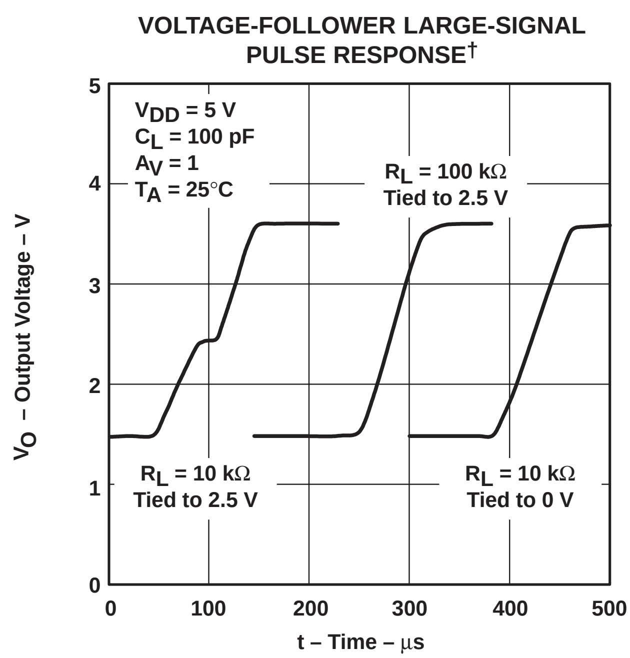


Figure 38

† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

INVERTING SMALL-SIGNAL PULSE RESPONSE†

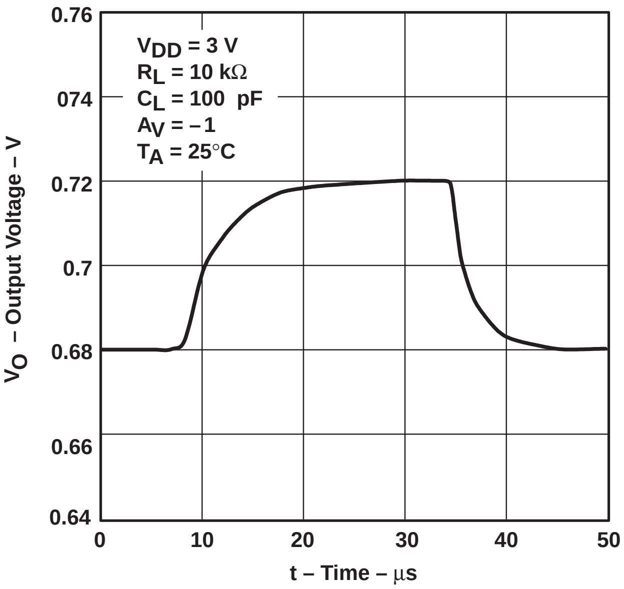


Figure 39

INVERTING SMALL-SIGNAL PULSE RESPONSE†

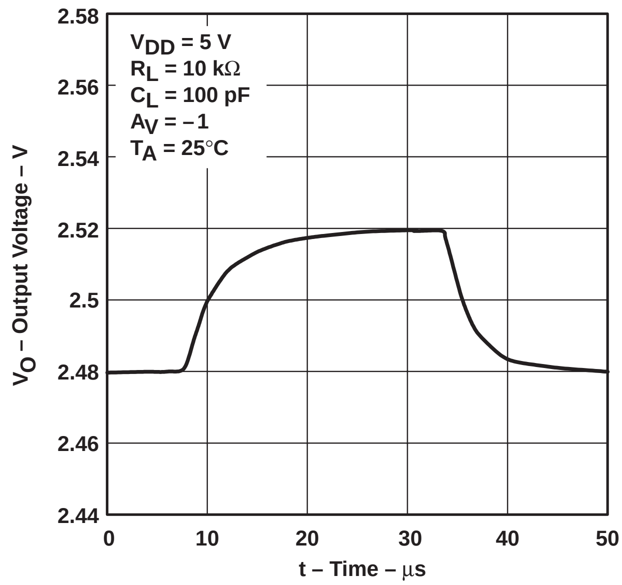


Figure 40

VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE†

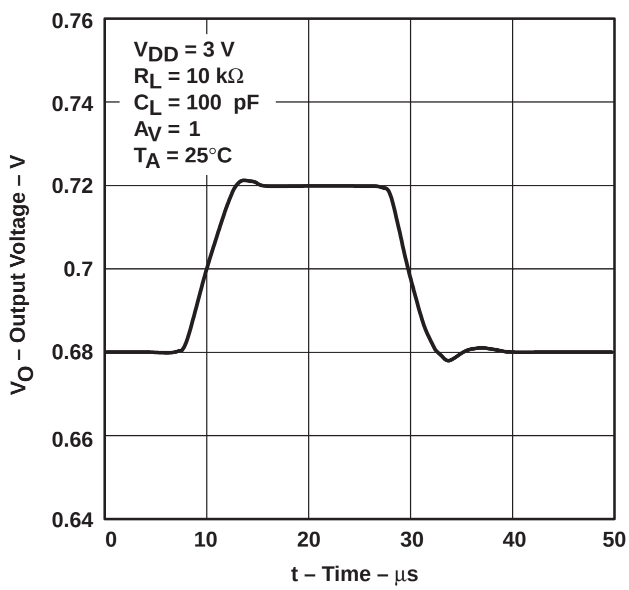


Figure 41

VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE†

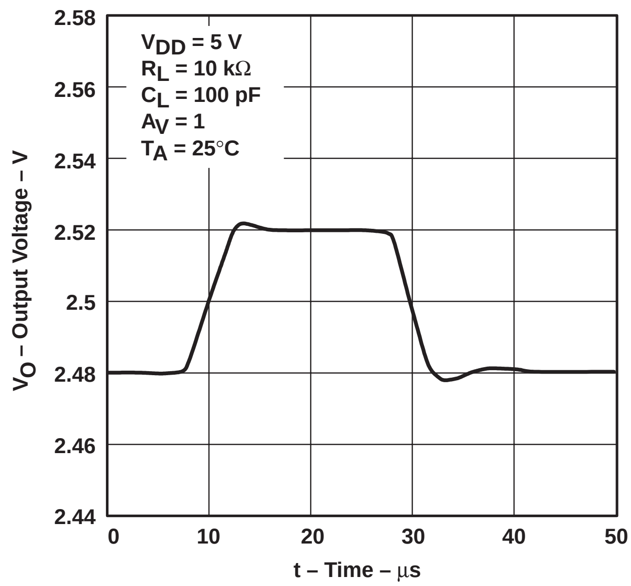


Figure 42

† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

EQUIVALENT INPUT NOISE VOLTAGE† vs FREQUENCY

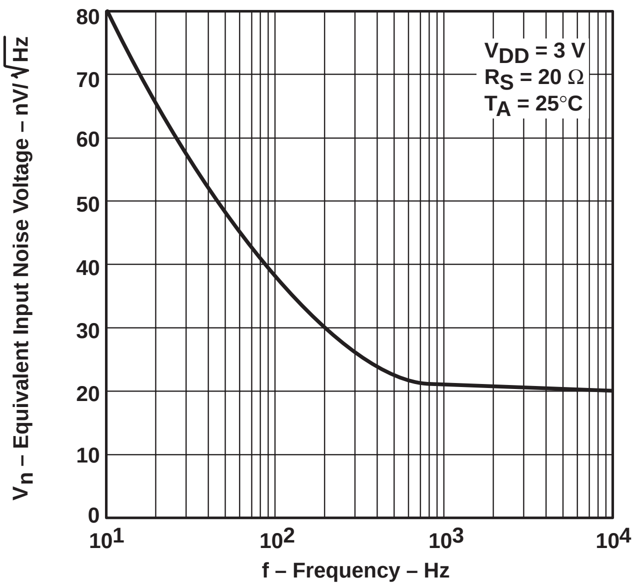


Figure 43

EQUIVALENT INPUT NOISE VOLTAGE† vs FREQUENCY

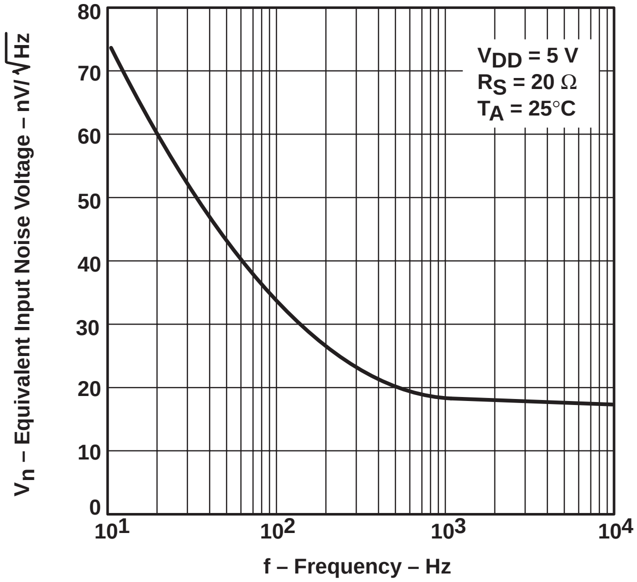


Figure 44

INPUT NOISE VOLTAGE OVER A 10-SECOND PERIOD†

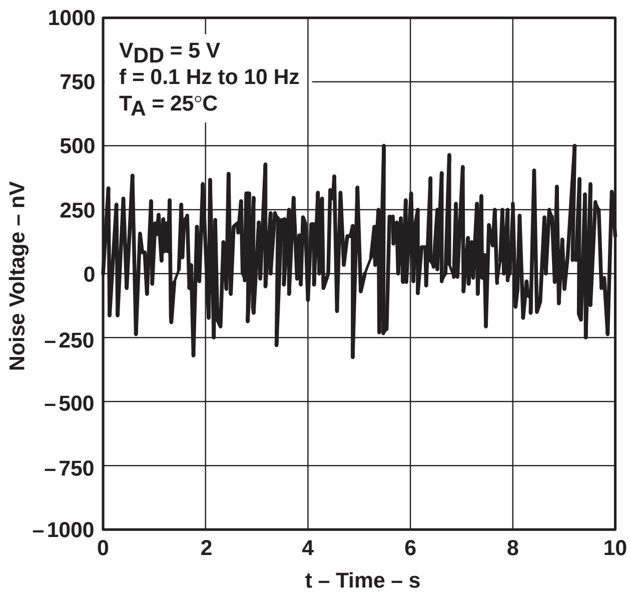


Figure 45

TOTAL HARMONIC DISTORTION PLUS NOISE† vs FREQUENCY

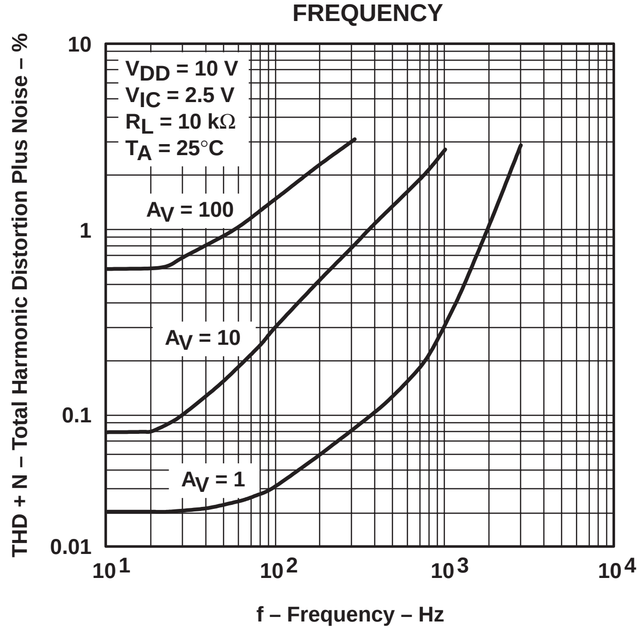


Figure 46

† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

GAIN-BANDWIDTH PRODUCT†‡ vs FREE-AIR TEMPERATURE

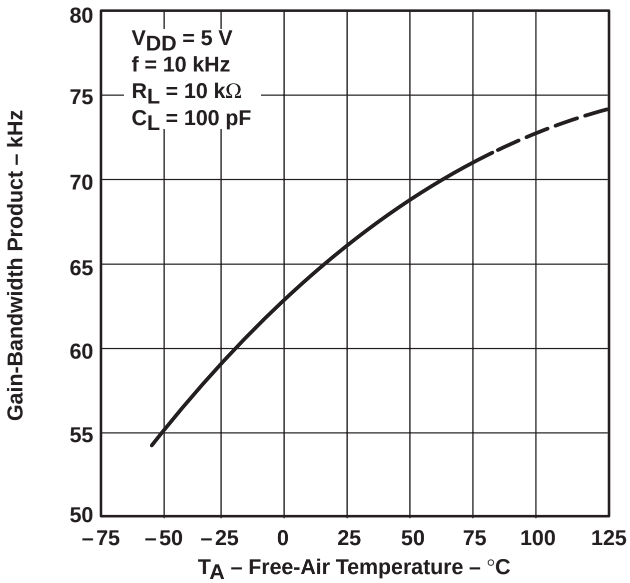


Figure 47

GAIN-BANDWIDTH PRODUCT vs SUPPLY VOLTAGE

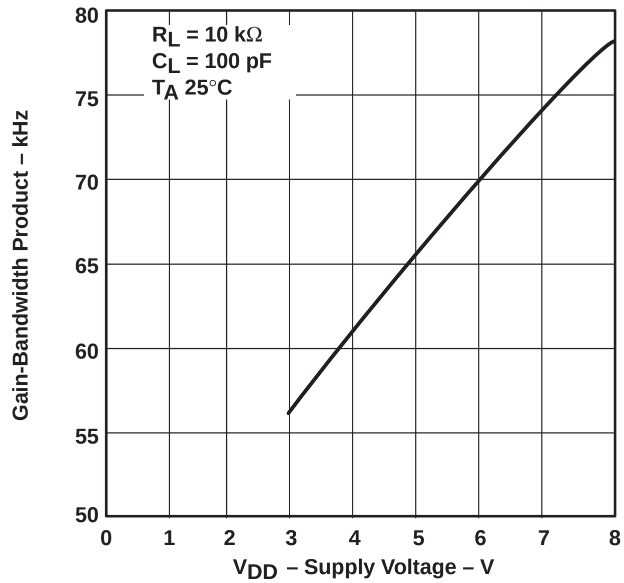


Figure 48

PHASE MARGIN vs LOAD CAPACITANCE

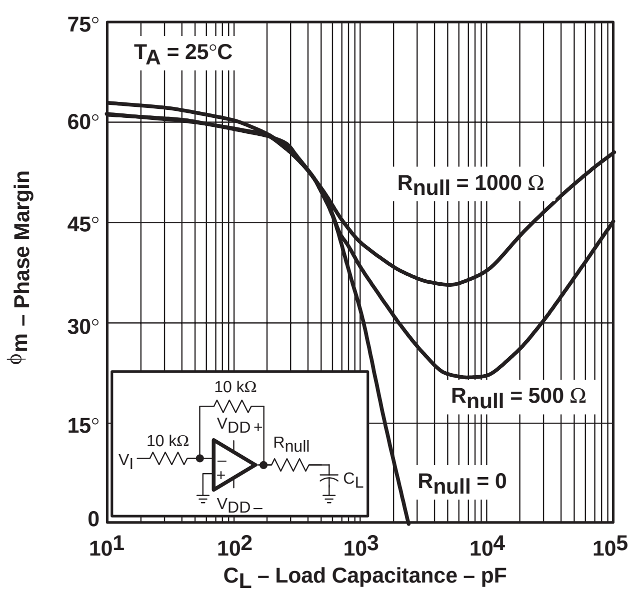


Figure 49

GAIN MARGIN vs LOAD CAPACITANCE

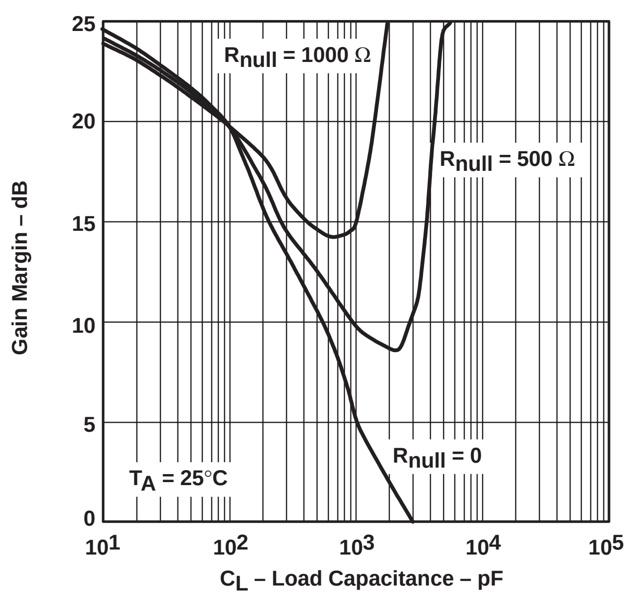


Figure 50

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.
‡ For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

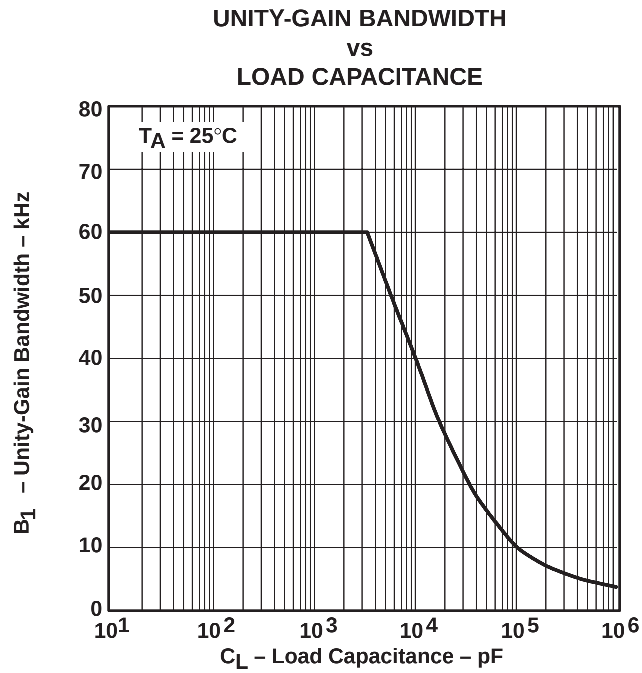


Figure 51

APPLICATION INFORMATION

driving large capacitive loads

The TLV2211 is designed to drive larger capacitive loads than most CMOS operational amplifiers. Figure 49 and Figure 50 illustrate its ability to drive loads up to 600 pF while maintaining good gain and phase margins (R_{null} = 0).

A smaller series resistor (R_{null}) at the output of the device (see Figure 52) improves the gain and phase margins when driving large capacitive loads. Figure 49 and Figure 50 show the effects of adding series resistances of 500 Ω and 1000 Ω. The addition of this series resistor has two effects: the first is that it adds a zero to the transfer function and the second is that it reduces the frequency of the pole associated with the output load in the transfer function.

The zero introduced to the transfer function is equal to the series resistance times the load capacitance. To calculate the improvement in phase margin, equation (1) can be used.

$$\Delta\phi_{m1} = \tan^{-1}\left(2 \times \pi \times UGBW \times R_{null} \times C_L\right) \tag{1}$$

where :

$\Delta\phi_{m1}$ = improvement in phase margin
UGBW = unity-gain bandwidth frequency
R_{null} = output series resistance
C_L = load capacitance

APPLICATION INFORMATION

driving large capacitive loads (continued)

The unity-gain bandwidth (UGBW) frequency decreases as the capacitive load increases (see Figure 51). To use equation (1), UGBW must be approximated from Figure 51.

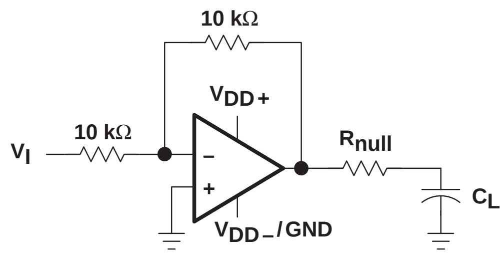


Figure 52. Series-Resistance Circuit

driving heavy dc loads

The TLV2211 is designed to provide better sinking and sourcing output currents than earlier CMOS rail-to-rail output devices. This device is specified to sink 500 µA and source 250 µA at V_{DD} = 3 V and V_{DD} = 5 V at a maximum quiescent I_{DD} of 25 µA. This provides a greater than 90% power efficiency.

When driving heavy dc loads, such as 10 kΩ, the positive edge under slewing conditions can experience some distortion. This condition can be seen in Figure 37. This condition is affected by three factors.

- Where the load is referenced. When the load is referenced to either rail, this condition does not occur. The distortion occurs only when the output signal swings through the point where the load is referenced. Figure 38 illustrates two 10-kΩ load conditions. The first load condition shows the distortion seen for a 10-kΩ load tied to 2.5 V. The third load condition shows no distortion for a 10-kΩ load tied to 0 V.
- Load resistance. As the load resistance increases, the distortion seen on the output decreases. Figure 38 illustrates the difference seen on the output for a 10-kΩ load and a 100-kΩ load with both tied to 2.5 V.
- Input signal edge rate. Faster input edge rates for a step input result in more distortion than with slower input edge rates.

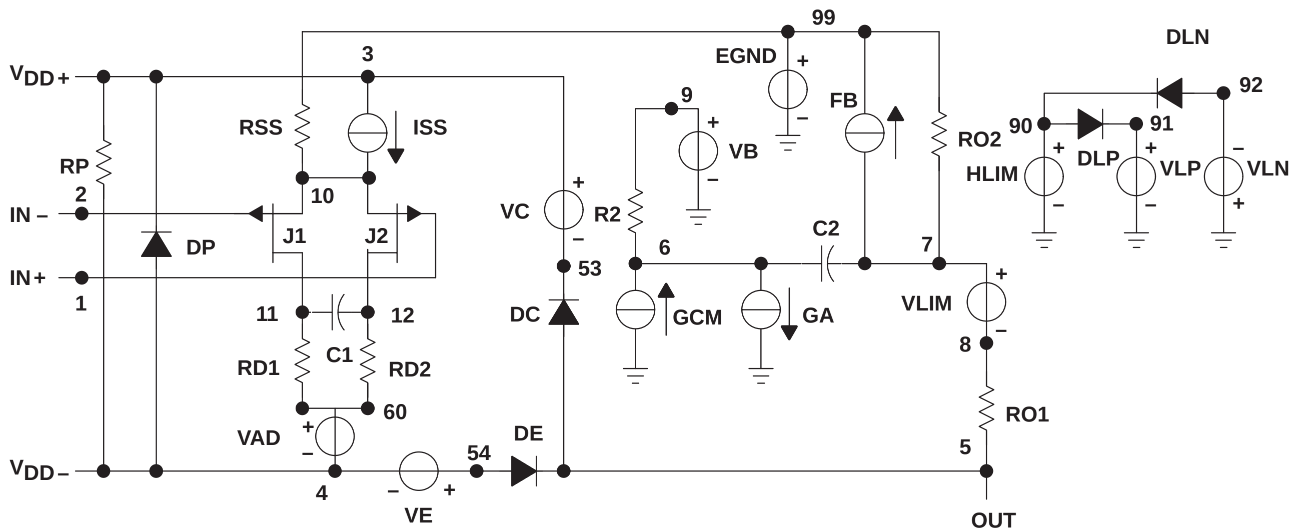
APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using Microsim *Parts*™, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 6) and subcircuit in Figure 53 are generated using the TLV2211 typical electrical and operating characteristics at T_A = 25°C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 6: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, “Macromodeling of Integrated Circuit Operational Amplifiers”, *IEEE Journal of Solid-State Circuits,* SC-9, 353 (1974).



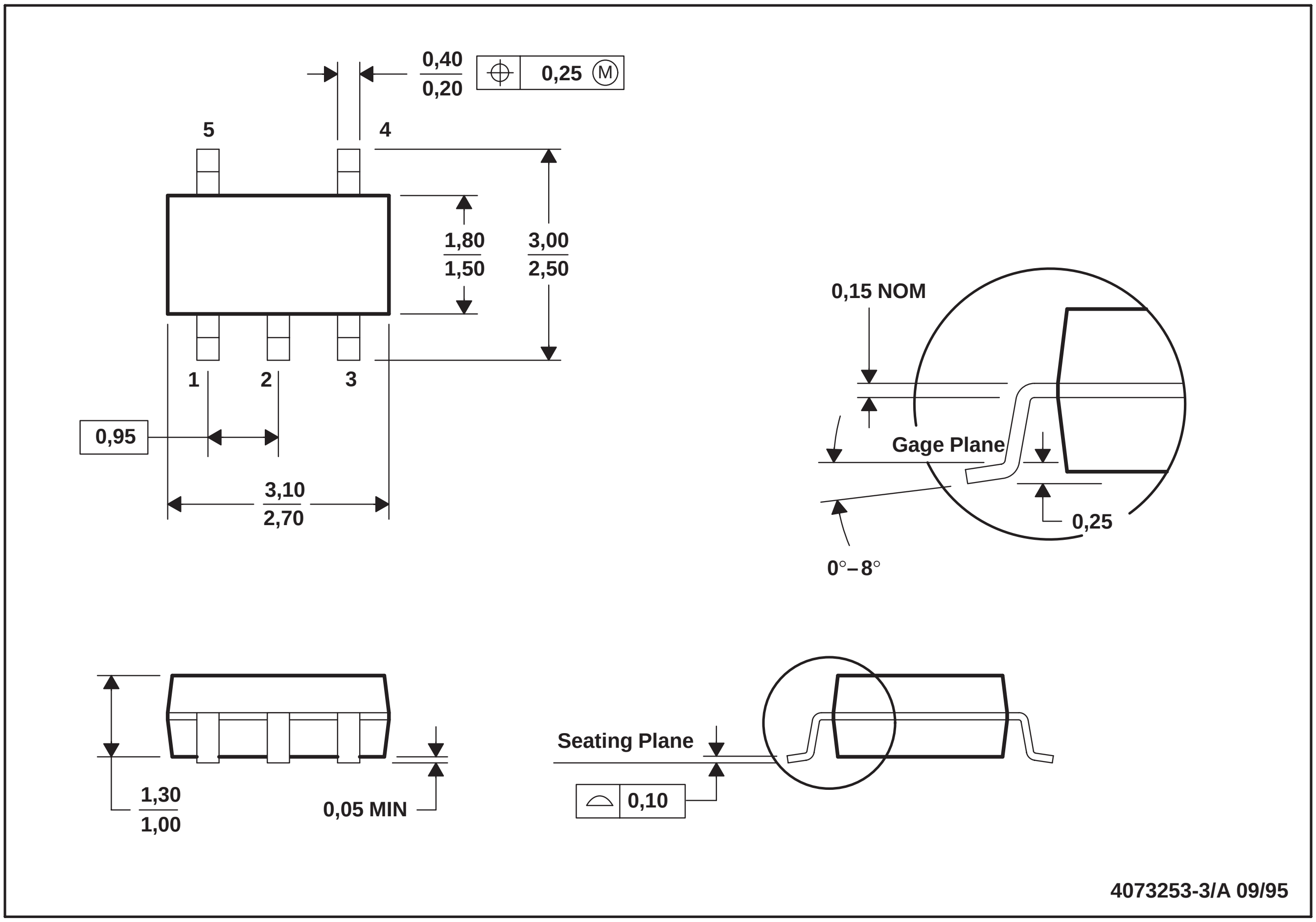

```
.SUBCKT TLV2211 1 2 3 4 5
     C1     11   12   8.86E–12
     C2     6    7    50.00E–12
     DC     5    53   DX
     DE     54   5    DX
     DLP    90   91   DX
     DLN    92   90   DX
     DP     4    3    DX
     EGND   99   0    POLY (2) (3,0) (4,0) 0 .5 .5
     FB     7    99   POLY (5) VB VC VE VLP
     + VLN 0 4.29E6 –6E6 6E6 6E6 –6E6
     GA     6    0    11   12 9.425E–6
     GCM    0    6    10   99 1320.2E–12
     ISS    3    10   DC 1.250E–6
     HLIM   90   0    VLIM 1K
     J1     11   2    10 JX
     J2     12   1    10 JX
     R2     6    9    100.0E3
     RD1    60   11   106.1E3
     RD2    60   12   106.1E3
     R01    8    5    50
     R02    7    99   150
     RP     3    4    419.2E3
     RSS    10   99   160.0E6
     VAD    60   4    –.5
     VB     9    0    DC 0
     VC     3    53   DC .55
     VE     54   4    DC .55
     VLIM   7    8    DC 0
     VLP    91   0    DC 0.1
     VLN    0    92   DC 2.6
.MODEL DX D (IS=800.0E–18)
.MODEL JX PJF (IS=500.0E–15 BETA=166E–6
+ VTO=–.004)
.ENDS
```

Figure 53. Boyle Macromodel and Subcircuit

PSpice and *Parts* are trademark of MicroSim Corporation.

MECHANICAL INFORMATION

DBV (R-PDSO-G5) **PLASTIC SMALL-OUTLINE PACKAGE**



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions include mold flash or protrusion.